

ZPMV2.E488074 - Wiring, Printed - Component

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ShenZhen JDB Technology Co LTD

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Shenzhen, Guangdong 518103 China

E488074

Type	Cond Width		Max Report					Max								
	Min	Cond	SS/	Area	date	Surface	Assembly	Solder	Solder	Oper	Meets	C				
	Min	Edge	Thk	DS/	Diam	After	Mount	Process	Process	Limits	Temp	Flame	UL796	T		
	mm	mm	mic	DSO	mm	2022-01-01	Technology	Temp °C	Cycles	°C	sec	°C	Class	DSR	I	
Multilayer printed wiring boards																
JDB-M	0.1	0.1	17 Int:34	DS	25.4	No	-	-	-	288	20	130	V-0	All	*	
Single layer Metal Base printed wiring boards																
JDB-A1(ASP1)	0.13	0.20	17	SS	50.8	Yes	Yes	260	1	288	10	90	V-0	All	0	
JDB-A2(ASP1)	0.13	0.20	17	SS	50.8	Yes	Yes	260	1	288	10	130	V-0	All	0	
Single layer Metal Base printed wiring boards, flammability only recognition																
JDB-A3(ASP1)	-	-	-	DS	-	Yes	Yes	260	2	288	10	-	V-0	-	-	
Single layer printed wiring boards																
JDB-D	0.1	0.1	17	DS	25.4	No	-	-	-	288	20	130	V-0	All	*	

* - CTI marking is optional and may be marked on the printed wiring board.

ASP1 - Assembly Solder process evaluated to IPC-TM-650, 2.6.27 Thermal Stress Assembly Simulation.

Marking: Company name or file number and type designation. May be followed by a suffix to denote factory identification or flammability classification..

Last Updated on 2023-03-16



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